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## Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	216
Number of Logic Elements/Cells	1728
Total RAM Bits	24576
Number of I/O	102
Number of Gates	119000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep1k30tc144-2

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## ...and More Features

- -1 speed grade devices are compliant with *PCI Local Bus Specification, Revision 2.2* for 5.0-V operation
- Built-in Joint Test Action Group (JTAG) boundary-scan test (BST) circuitry compliant with IEEE Std. 1149.1-1990, available without consuming additional device logic.
- Operate with a 2.5-V internal supply voltage
- In-circuit reconfigurability (ICR) via external configuration devices, intelligent controller, or JTAG port
- ClockLock™ and ClockBoost™ options for reduced clock delay, clock skew, and clock multiplication
- Built-in, low-skew clock distribution trees
- 100% functional testing of all devices; test vectors or scan chains are not required
- Pull-up on I/O pins before and during configuration

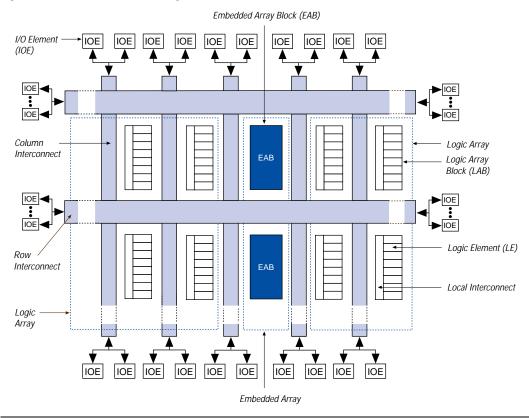
#### ■ Flexible interconnect

- FastTrack® Interconnect continuous routing structure for fast, predictable interconnect delays
- Dedicated carry chain that implements arithmetic functions such as fast adders, counters, and comparators (automatically used by software tools and megafunctions)
- Dedicated cascade chain that implements high-speed, high-fan-in logic functions (automatically used by software tools and megafunctions)
- Tri-state emulation that implements internal tri-state buses
- Up to six global clock signals and four global clear signals

#### Powerful I/O pins

- Individual tri-state output enable control for each pin
- Open-drain option on each I/O pin
- Programmable output slew-rate control to reduce switching noise
- Clamp to V<sub>CCIO</sub> user-selectable on a pin-by-pin basis
- Supports hot-socketing

Figure 1. ACEX 1K Device Block Diagram



ACEX 1K devices provide six dedicated inputs that drive the flipflops' control inputs and ensure the efficient distribution of high-speed, low-skew (less than 1.0 ns) control signals. These signals use dedicated routing channels that provide shorter delays and lower skews than the FastTrack Interconnect routing structure. Four of the dedicated inputs drive four global signals. These four global signals can also be driven by internal logic, providing an ideal solution for a clock divider or an internally generated asynchronous clear signal that clears many registers in the device.

#### Carry Chain

The carry chain provides a very fast (as low as 0.2 ns) carry-forward function between LEs. The carry-in signal from a lower-order bit drives forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the ACEX 1K architecture to efficiently implement high-speed counters, adders, and comparators of arbitrary width. Carry chain logic can be created automatically by the compiler during design processing, or manually by the designer during design entry. Parameterized functions, such as LPM and DesignWare functions, automatically take advantage of carry chains.

Carry chains longer than eight LEs are automatically implemented by linking LABs together. For enhanced fitting, a long carry chain skips alternate LABs in a row. A carry chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from odd-numbered LAB to odd-numbered LAB. For example, the last LE of the first LAB in a row carries to the first LE of the third LAB in the row. The carry chain does not cross the EAB at the middle of the row. For instance, in the EP1K50 device, the carry chain stops at the eighteenth LAB, and a new carry chain begins at the nineteenth LAB.

Figure 9 shows how an n-bit full adder can be implemented in n+1 LEs with the carry chain. One portion of the LUT generates the sum of two bits using the input signals and the carry-in signal; the sum is routed to the output of the LE. The register can be bypassed for simple adders or used for an accumulator function. Another portion of the LUT and the carry chain logic generates the carry-out signal, which is routed directly to the carry-in signal of the next-higher-order bit. The final carry-out signal is routed to an LE, where it can be used as a general-purpose signal.

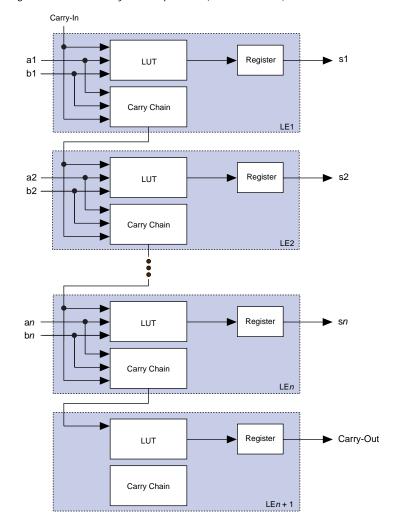
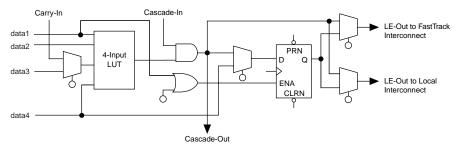


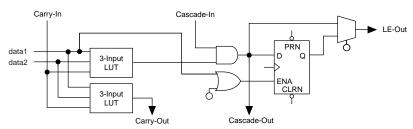
Figure 9. ACEX 1K Carry Chain Operation (n-Bit Full Adder)

Figure 11. ACEX 1K LE Operating Modes

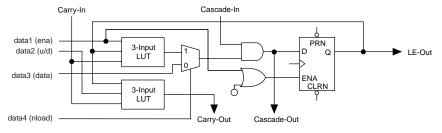
#### **Normal Mode**



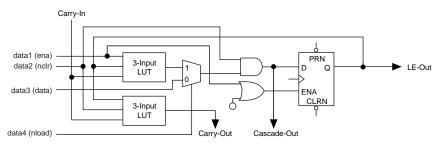
#### **Arithmetic Mode**



#### **Up/Down Counter Mode**



#### **Clearable Counter Mode**



In addition to the six clear and preset modes, ACEX 1K devices provide a chip-wide reset pin that can reset all registers in the device. Use of this feature is set during design entry. In any of the clear and preset modes, the chip-wide reset overrides all other signals. Registers with asynchronous presets may be preset when the chip-wide reset is asserted. Inversion can be used to implement the asynchronous preset. Figure 12 shows examples of how to setup the preset and clear inputs for the desired functionality.

Figure 12. ACEX 1K LE Clear & Preset Modes

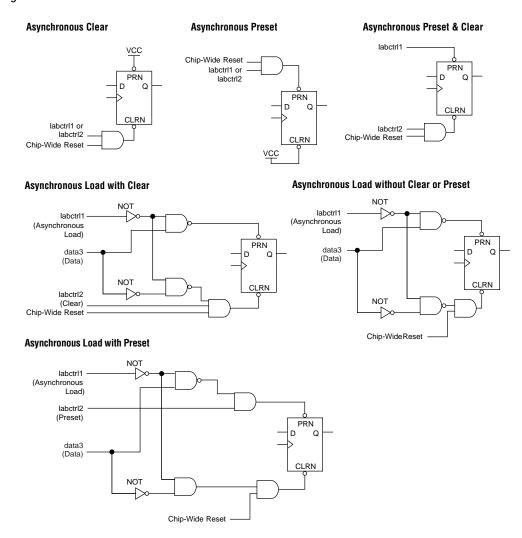


Figure 15. ACEX 1K Bidirectional I/O Registers

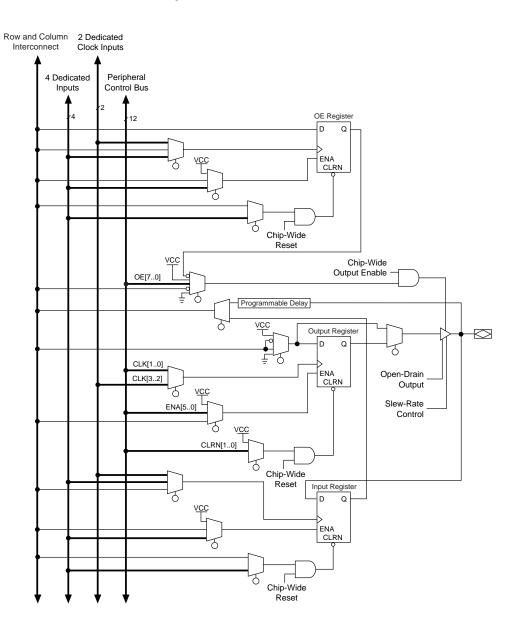


Table 12.	ClockLock & ClockBoost Parameters for -2	? Speed-Grade De	vices			
Symbol	Parameter	Condition	Min	Тур	Max	Unit
$t_R$	Input rise time				5	ns
$t_{\digamma}$	Input fall time				5	ns
t <sub>INDUTY</sub>	Input duty cycle		40		60	%
f <sub>CLK1</sub>	Input clock frequency (ClockBoost clock multiplication factor equals 1)		25		80	MHz
f <sub>CLK2</sub>	Input clock frequency (ClockBoost clock multiplication factor equals 2)		16		40	MHz
f <sub>CLKDEV</sub>	Input deviation from user specification in the software (1)				25,000	PPM
t <sub>INCLKSTB</sub>	Input clock stability (measured between adjacent clocks)				100	ps
t <sub>LOCK</sub>	Time required for ClockLock or ClockBoost to acquire lock (3)				10	μs
t <sub>JITTER</sub>	Jitter on ClockLock or ClockBoost-	$t_{INCLKSTB}$ < 100			250 <i>(4)</i>	ps
	generated clock (4)	t <sub>INCLKSTB</sub> < 50			200 (4)	ps
toutduty	Duty cycle for ClockLock or ClockBoost- generated clock		40	50	60	%

#### Notes to tables:

- (1) To implement the ClockLock and ClockBoost circuitry with the Altera software, designers must specify the input frequency. The Altera software tunes the PLL in the ClockLock and ClockBoost circuitry to this frequency. The f<sub>CLKDEV</sub> parameter specifies how much the incoming clock can differ from the specified frequency during device operation. Simulation does not reflect this parameter.
- (2) Twenty-five thousand parts per million (PPM) equates to 2.5% of input clock period.
- (3) During device configuration, the ClockLock and ClockBoost circuitry is configured before the rest of the device. If the incoming clock is supplied during configuration, the ClockLock and ClockBoost circuitry locks during configuration because the  $t_{LOCK}$  value is less than the time required for configuration.
- (4) The  $t_{IITTER}$  specification is measured under long-term observation. The maximum value for  $t_{IITTER}$  is 200 ps if  $t_{INCLKSTB}$  is lower than 50 ps.

# I/O Configuration

This section discusses the PCI pull-up clamping diode option, slew-rate control, open-drain output option, and MultiVolt I/O interface for ACEX 1K devices. The PCI pull-up clamping diode, slew-rate control, and open-drain output options are controlled pin-by-pin via Altera software logic options. The MultiVolt I/O interface is controlled by connecting  $V_{\rm CCIO}$  to a different voltage than  $V_{\rm CCINT}$ . Its effect can be simulated in the Altera software via the **Global Project Device Options** dialog box (Assign menu).

Figure 20. ACEX 1K JTAG Waveforms

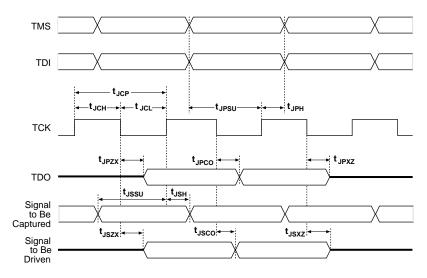


Table 17 shows the timing parameters and values for ACEX 1K devices.

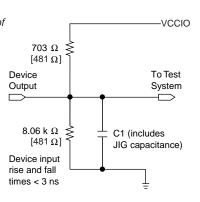
Symbol	Parameter	Min	Max	Unit
t <sub>JCP</sub>	TCK clock period	100		ns
t <sub>JCH</sub>	TCK clock high time	50		ns
t <sub>JCL</sub>	TCK clock low time	50		ns
t <sub>JPSU</sub>	JTAG port setup time	20		ns
t <sub>JPH</sub>	JTAG port hold time	45		ns
t <sub>JPCO</sub>	JTAG port clock to output		25	ns
t <sub>JPZX</sub>	JTAG port high impedance to valid output		25	ns
t <sub>JPXZ</sub>	JTAG port valid output to high impedance		25	ns
t <sub>JSSU</sub>	Capture register setup time	20		ns
t <sub>JSH</sub>	Capture register hold time	45		ns
t <sub>JSCO</sub>	Update register clock to output		35	ns
t <sub>JSZX</sub>	Update register high impedance to valid output		35	ns
t <sub>JSXZ</sub>	Update register valid output to high impedance		35	ns

### **Generic Testing**

Each ACEX 1K device is functionally tested. Complete testing of each configurable static random access memory (SRAM) bit and all logic functionality ensures 100% yield. AC test measurements for ACEX 1K devices are made under conditions equivalent to those shown in Figure 21. Multiple test patterns can be used to configure devices during all stages of the production flow.

Figure 21. ACEX 1K AC Test Conditions

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-groundcurrent transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in brackets are for 2.5-V devices or outputs. Numbers without brackets are for 3.3-V devices or outputs.



## Operating Conditions

Tables 18 through 21 provide information on absolute maximum ratings, recommended operating conditions, DC operating conditions, and capacitance for 2.5-V ACEX 1K devices.

Table 1	8. ACEX 1K Device Absolute I	Maximum Ratings Note (1)			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CCINT</sub>	Supply voltage	With respect to ground (2)	-0.5	3.6	V
V <sub>CCIO</sub>			-0.5	4.6	V
V <sub>I</sub>	DC input voltage		-2.0	5.75	V
I <sub>OUT</sub>	DC output current, per pin		-25	25	mA
T <sub>STG</sub>	Storage temperature	No bias	-65	150	° C
T <sub>AMB</sub>	Ambient temperature	Under bias	-65	135	° C
TJ	Junction temperature	PQFP, TQFP, and BGA packages, under bias		135	° C

Table 2	1. ACEX 1K Device Capacitan	ce Note (14)			
Symbol	Parameter	Conditions	Min	Max	Unit
C <sub>IN</sub>	Input capacitance	V <sub>IN</sub> = 0 V, f = 1.0 MHz		10	pF
C <sub>INCLK</sub>	Input capacitance on dedicated clock pin	V <sub>IN</sub> = 0 V, f = 1.0 MHz		12	pF
C <sub>OUT</sub>	Output capacitance	V <sub>OUT</sub> = 0 V, f = 1.0 MHz		10	pF

#### Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage is -0.5 V. During transitions, the inputs may undershoot to -2.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial- and extended-temperature-range devices.
- (4) Maximum  $V_{CC}$  rise time is 100 ms, and  $V_{CC}$  must rise monotonically.
- (5) All pins, including dedicated inputs, clock, I/O, and JTAG pins, may be driven before V<sub>CCINT</sub> and V<sub>CCIO</sub> are powered.
- (6) Typical values are for  $T_A = 25^{\circ}$  C,  $V_{CCINT} = 2.5$  V, and  $V_{CCIO} = 2.5$  V or 3.3 V.
- (7) These values are specified under the ACEX 1K Recommended Operating Conditions shown in Table 19 on page 46.
- (8) The ACEX 1K input buffers are compatible with 2.5-V, 3.3-V (LVTTL and LVCMOS), and 5.0-V TTL and CMOS signals. Additionally, the input buffers are 3.3-V PCI compliant when V<sub>CCIO</sub> and V<sub>CCINT</sub> meet the relationship shown in Figure 22.
- The I<sub>OH</sub> parameter refers to high-level TTL, PCI, or CMOS output current.
- (10) The  $I_{OL}$  parameter refers to low-level TTL, PCI, or CMOS output current. This parameter applies to open-drain pins as well as output pins.
- (11) This value is specified for normal device operation. The value may vary during power-up.
- (12) This parameter applies to -1 speed grade commercial temperature devices and -2 speed grade industrial and extended temperature devices.
- (13) Pin pull-up resistance values will be lower if the pin is driven higher than V<sub>CCIO</sub> by an external source.
- (14) Capacitance is sample-tested only.

Figure 22 shows the required relationship between  $V_{CCIO}$  and  $V_{CCINT}$  to satisfy 3.3-V PCI compliance.

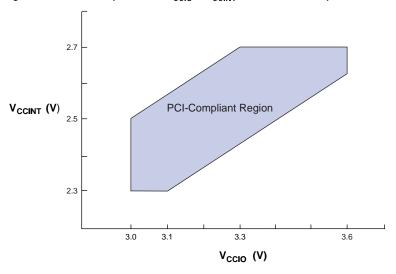


Figure 22. Relationship between V<sub>CCIO</sub> & V<sub>CCINT</sub> for 3.3-V PCI Compliance

Figure 23 shows the typical output drive characteristics of ACEX 1K devices with 3.3-V and 2.5-V  $V_{\rm CCIO}$ . The output driver is compliant to the 3.3-V *PCI Local Bus Specification, Revision 2.2* (when VCCIO pins are connected to 3.3 V). ACEX 1K devices with a -1 speed grade also comply with the drive strength requirements of the *PCI Local Bus Specification, Revision 2.2* (when VCCINT pins are powered with a minimum supply of 2.375 V, and VCCIO pins are connected to 3.3 V). Therefore, these devices can be used in open 5.0-V PCI systems.

Symbol	Speed Grade							
	_	1 -2		-2		3		
	Min	Max	Min	Max	Min	Max		
$t_{IOD}$		2.6		3.1		4.0	ns	
t <sub>IOC</sub>		0.3		0.4		0.5	ns	
t <sub>IOCO</sub>		0.9		1.0		1.4	ns	
t <sub>IOCOMB</sub>		0.0		0.0		0.0	ns	
t <sub>IOSU</sub>	1.3		1.5		2.0		ns	
t <sub>IOH</sub>	0.9		1.0		1.4		ns	
t <sub>IOCLR</sub>		1.1		1.3		1.7	ns	
t <sub>OD1</sub>		3.1		3.7		4.1	ns	
t <sub>OD2</sub>		2.6		3.3		3.9	ns	
t <sub>OD3</sub>		5.8		6.9		8.3	ns	
$t_{XZ}$		3.8		4.5		5.9	ns	
$t_{ZX1}$		3.8		4.5		5.9	ns	
$t_{ZX2}$		3.3		4.1		5.7	ns	
$t_{ZX3}$		6.5		7.7		10.1	ns	
t <sub>INREG</sub>		3.7		4.3		5.7	ns	
t <sub>IOFD</sub>		0.9		1.0		1.4	ns	
t <sub>INCOMB</sub>		1.9		2.3		3.0	ns	

Symbol			Speed	Grade			Unit
	-	1	-	2	-	3	
	Min	Max	Min	Max	Min	Max	
t <sub>EABDATA1</sub>		1.8		1.9		1.9	ns
t <sub>EABDATA2</sub>		0.6		0.7		0.7	ns
t <sub>EABWE1</sub>		1.2		1.2		1.2	ns
t <sub>EABWE2</sub>		0.4		0.4		0.4	ns
t <sub>EABRE1</sub>		0.9		0.9		0.9	ns
t <sub>EABRE2</sub>		0.4		0.4		0.4	ns
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns
t <sub>EABCO</sub>		0.3		0.3		0.3	ns
t <sub>EABBYPASS</sub>		0.5		0.6		0.6	ns
t <sub>EABSU</sub>	1.0		1.0		1.0		ns
t <sub>EABH</sub>	0.5		0.4		0.4		ns
t <sub>EABCLR</sub>	0.3		0.3		0.3		ns
$t_{AA}$		3.4		3.6		3.6	ns
$t_{WP}$	2.7		2.8		2.8		ns
$t_{RP}$	1.0		1.0		1.0		ns
t <sub>WDSU</sub>	1.0		1.0		1.0		ns
t <sub>WDH</sub>	0.1		0.1		0.1		ns
t <sub>WASU</sub>	1.8		1.9		1.9		ns
t <sub>WAH</sub>	1.9		2.0		2.0		ns
t <sub>RASU</sub>	3.1		3.5		3.5		ns
t <sub>RAH</sub>	0.2		0.2		0.2		ns
$t_{WO}$		2.7		2.8		2.8	ns
$t_{DD}$		2.7		2.8		2.8	ns
t <sub>EABOUT</sub>		0.5		0.6		0.6	ns
t <sub>EABCH</sub>	1.5		2.0		2.0		ns
t <sub>EABCL</sub>	2.7		2.8		2.8		ns

Symbol			Speed	l Grade			Unit
	-	1	-	-2 -3			
	Min	Max	Min	Max	Min	Max	
t <sub>INSUBIDIR</sub> (2)	2.2		2.3		3.2		ns
t <sub>INHBIDIR</sub> (2)	0.0		0.0		0.0		ns
t <sub>OUTCOBIDIR</sub> (2)	2.0	6.6	2.0	7.8	2.0	9.6	ns
t <sub>XZBIDIR</sub> (2)		8.8		11.2		14.0	ns
t <sub>ZXBIDIR</sub> (2)		8.8		11.2		14.0	ns
t <sub>INSUBIDIR</sub> (4)	3.1		3.3		-	-	
t <sub>INHBIDIR</sub> (4)	0.0		0.0		-		
toutcobidir (4)	0.5	5.1	0.5	6.4	-	-	ns
t <sub>XZBIDIR</sub> (4)		7.3		9.2		-	ns
t <sub>ZXBIDIR</sub> (4)		7.3		9.2		-	ns

#### Notes to tables:

- (1) All timing parameters are described in Tables 22 through 29 in this data sheet.
- (2) This parameter is measured without the use of the ClockLock or ClockBoost circuits.
- (3) These parameters are specified by characterization.
- (4) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

Tables 37 through 43 show EP1K30 device internal and external timing parameters.

Symbol			Speed Grade						
	-	1	-2 -3						
	Min	Max	Min	Max	Min	Max			
$t_{LUT}$		0.7		0.8		1.1	ns		
t <sub>CLUT</sub>		0.5		0.6		0.8	ns		
t <sub>RLUT</sub>		0.6		0.7		1.0	ns		
t <sub>PACKED</sub>		0.3		0.4		0.5	ns		
$t_{EN}$		0.6		0.8		1.0	ns		
t <sub>CICO</sub>		0.1		0.1		0.2	ns		
t <sub>CGEN</sub>		0.4		0.5		0.7	ns		
t <sub>CGENR</sub>		0.1		0.1		0.2	ns		
t <sub>CASC</sub>		0.6		0.8		1.0	ns		
t <sub>C</sub>		0.0		0.0		0.0	ns		
t <sub>co</sub>		0.3		0.4		0.5	ns		

Table 37. EP1K3	0 Device LE 1	Timing Micr	oparameters	(Part 2 of .	<b>2)</b> Note	(1)	
Symbol			Speed	Grade			Unit
	_	1	-	2	-	-3	
	Min	Max	Min	Max	Min	Max	
t <sub>COMB</sub>		0.4		0.4		0.6	ns
$t_{SU}$	0.4		0.6		0.6		ns
t <sub>H</sub>	0.7		1.0		1.3		ns
t <sub>PRE</sub>		0.8		0.9		1.2	ns
$t_{CLR}$		0.8		0.9		1.2	ns
t <sub>CH</sub>	2.0		2.5		2.5		ns
$t_{CL}$	2.0		2.5		2.5		ns

Symbol		Speed Grade							
	-	1	-	2 -		3			
	Min	Max	Min	Max	Min	Max			
t <sub>IOD</sub>		2.4		2.8		3.8	ns		
t <sub>ioc</sub>		0.3		0.4		0.5	ns		
t <sub>IOCO</sub>		1.0		1.1		1.6	ns		
t <sub>IOCOMB</sub>		0.0		0.0		0.0	ns		
t <sub>iosu</sub>	1.2		1.4		1.9		ns		
<sup>t</sup> ioн	0.3		0.4		0.5		ns		
t <sub>IOCLR</sub>		1.0		1.1		1.6	ns		
t <sub>OD1</sub>		1.9		2.3		3.0	ns		
OD2		1.4		1.8		2.5	ns		
t <sub>OD3</sub>		4.4		5.2		7.0	ns		
t <sub>XZ</sub>		2.7		3.1	•	4.3	ns		
t <sub>ZX1</sub>		2.7		3.1	•	4.3	ns		
t <sub>ZX2</sub>		2.2		2.6	•	3.8	ns		
tzx3		5.2		6.0		8.3	ns		
INREG		3.4		4.1	•	5.5	ns		
IOFD		0.8		1.3		2.4	ns		
t <sub>INCOMB</sub>		0.8		1.3		2.4	ns		

Symbol			Speed	Grade			Unit	
	_	1	-	2	-	3	]	
	Min	Max	Min	Max	Min	Max		
t <sub>EABDATA1</sub>		1.7		2.4		3.2	ns	
t <sub>EABDATA2</sub>		0.4		0.6		0.8	ns	
t <sub>EABWE1</sub>		1.0		1.4		1.9	ns	
t <sub>EABWE2</sub>		0.0		0.0		0.0	ns	
t <sub>EABRE1</sub>		0.0		0.0		0.0		
t <sub>EABRE2</sub>		0.4		0.6		0.8	-	
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns	
t <sub>EABCO</sub>		0.8		1.1		1.5	ns	
t <sub>EABBYPASS</sub>		0.0		0.0		0.0	ns	
t <sub>EABSU</sub>	0.7		1.0		1.3		ns	
t <sub>EABH</sub>	0.4		0.6		0.8		ns	
t <sub>EABCLR</sub>	0.8		1.1		1.5			
$t_{AA}$		2.0		2.8		3.8	ns	
$t_{WP}$	2.0		2.8		3.8		ns	
t <sub>RP</sub>	1.0		1.4		1.9			
t <sub>WDSU</sub>	0.5		0.7		0.9		ns	
t <sub>WDH</sub>	0.1		0.1		0.2		ns	
t <sub>WASU</sub>	1.0		1.4		1.9		ns	
t <sub>WAH</sub>	1.5		2.1		2.9		ns	
t <sub>RASU</sub>	1.5		2.1		2.8			
t <sub>RAH</sub>	0.1		0.1		0.2			
$t_{WO}$		2.1		2.9		4.0	ns	
t <sub>DD</sub>		2.1		2.9		4.0	ns	
t <sub>EABOUT</sub>		0.0		0.0		0.0	ns	
t <sub>EABCH</sub>	1.5		2.0		2.5		ns	
t <sub>EABCL</sub>	1.5		2.0		2.5		ns	

Symbol	Speed Grade						
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>INSUBIDIR</sub> (2)	2.7		3.2		4.3		ns
t <sub>INHBIDIR</sub> (2)	0.0		0.0		0.0		ns
t <sub>INSUBIDIR</sub> (3)	3.7		4.2		-		ns
t <sub>INHBIDIR</sub> (3)	0.0		0.0		-		ns
toutcobidir (2)	2.0	4.5	2.0	5.2	2.0	7.3	ns
t <sub>XZBIDIR</sub> (2)		6.8		7.8		10.1	ns
t <sub>ZXBIDIR</sub> (2)		6.8		7.8		10.1	ns
toutcobidir (3)	0.5	3.5	0.5	4.2	-	-	
t <sub>XZBIDIR</sub> (3)		6.8		8.4		-	ns
t <sub>ZXBIDIR</sub> (3)		6.8		8.4		_	ns

#### Notes to tables:

- All timing parameters are described in Tables 22 through 29. This parameter is measured without use of the ClockLock or ClockBoost circuits. (2)
- This parameter is measured with use of the ClockLock or ClockBoost circuits (3)

Tables 51 through 57 show EP1K100 device internal and external timing parameters.

Symbol	Speed Grade						
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		0.7		1.0		1.5	ns
t <sub>CLUT</sub>		0.5		0.7		0.9	ns
t <sub>RLUT</sub>		0.6		0.8		1.1	ns
t <sub>PACKED</sub>		0.3		0.4		0.5	ns
t <sub>EN</sub>		0.2		0.3		0.3	ns
t <sub>CICO</sub>		0.1		0.1		0.2	ns
t <sub>CGEN</sub>		0.4		0.5		0.7	ns
t <sub>CGENR</sub>		0.1		0.1		0.2	ns
t <sub>CASC</sub>		0.6		0.9		1.2	ns
$t_{C}$		0.8		1.0		1.4	ns
t <sub>CO</sub>		0.6		0.8		1.1	ns
t <sub>COMB</sub>		0.4		0.5		0.7	ns
t <sub>SU</sub>	0.4		0.6		0.7		ns
$t_H$	0.5		0.7		0.9		ns
t <sub>PRE</sub>		0.8		1.0		1.4	ns
t <sub>CLR</sub>		0.8		1.0		1.4	ns
t <sub>CH</sub>	1.5		2.0		2.5		ns
t <sub>CL</sub>	1.5		2.0		2.5		ns

Symbol	Speed Grade						
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>EABAA</sub>		5.9		7.6		9.9	ns
t <sub>EABRCOMB</sub>	5.9		7.6		9.9		ns
t <sub>EABRCREG</sub>	5.1		6.5		8.5		ns
t <sub>EABWP</sub>	2.7		3.5		4.7		ns
t <sub>EABWCOMB</sub>	5.9		7.7		10.3		ns
t <sub>EABWCREG</sub>	5.4		7.0		9.4		ns
t <sub>EABDD</sub>		3.4		4.5		5.9	ns
t <sub>EABDATA</sub> CO		0.5		0.7		0.8	ns
t <sub>EABDATASU</sub>	0.8		1.0		1.4		ns
t <sub>EABDATAH</sub>	0.1		0.1		0.2		ns
t <sub>EABWESU</sub>	1.1		1.4		1.9		ns
t <sub>EABWEH</sub>	0.0		0.0		0.0		ns
t <sub>EABWDSU</sub>	1.0		1.3		1.7		ns
t <sub>EABWDH</sub>	0.2		0.2		0.3		ns
t <sub>EABWASU</sub>	4.1		5.2		6.8		ns
t <sub>EABWAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWO</sub>		3.4		4.5		5.9	ns